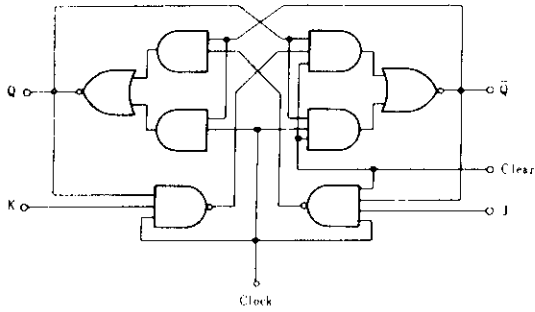
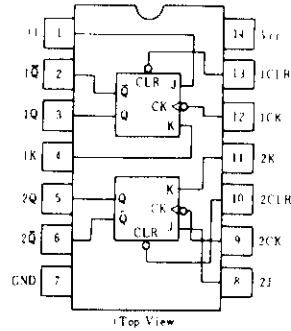


# HD74LS107A ● Dual J-K Negative-edge-triggered Flip-Flops (with Clear)

## ■ BLOCK DIAGRAM (1/2)



## ■ PIN ARRANGEMENT



## ■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Clock frequency	$f_{clock}$	0	-	30	MHz
Pulse width	Clock High	20	-	-	ns
	Clear Low	25	-	-	ns
Setup time	"H" Data	20↓	-	-	ns
	"L" Data	20↓	-	-	ns
Hold time	$t_h$	0↓	-	-	ns

Note) ↓; The arrow indicates the falling edge.

## ■ FUNCTION TABLE

Inputs				Outputs	
Clear	Clock	J	K	Q	$\bar{Q}$
L	X	X	X	L	H
H	↓	L	L	$Q_0$	$\bar{Q}_0$
H	↓	H	L	H	L
H	↓	L	H	L	H
H	↓	H	H	Toggle	
H	H	X	X	$Q_0$	$\bar{Q}_0$

Notes) H; high level, L; low level, X; irrelevant

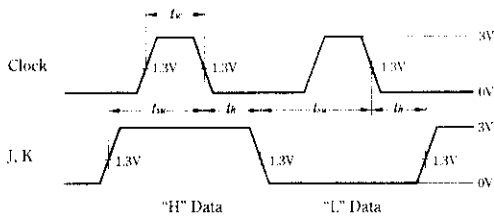
↓; transition from high to low level

$Q_0$ ; level of Q before the indicated steady-state input conditions were established.

$\bar{Q}_0$ ; complement of  $Q_0$  or level of  $\bar{Q}$  before the indicated steady-state input conditions were established.

Toggle; each output changes to the complement of its previous level on each active transition indicated by ↓.

## ■ TIMING DEFINITION



## ■ ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim +75^\circ\text{C}$ )

Item	Symbol	Test Conditions	min	typ*	max	Unit	
Input voltage	$V_{IH}$		2.0	—	—	V	
	$V_{IL}$		—	—	0.8	V	
Output voltage	$V_{OH}$	$V_{CC} = 4.75\text{V}, V_{IH} = 2\text{V}, V_{IL} = 0.8\text{V}, I_{OH} = -400\mu\text{A}$	2.7	—	—	V	
	$V_{OL}$	$V_{CC} = 4.75\text{V}, V_{IH} = 2\text{V}$	—	—	0.5	V	
		$V_{IL} = 0.8\text{V}$	$I_{OL} = 8\text{mA}$	—	—	0.4	V
Input current	J, K Clear Clock	$I_{IH}$	$V_{CC} = 5.25\text{V}, V_I = 2.7\text{V}$	—	—	20	$\mu\text{A}$
				—	—	60	
				—	—	80	
	J, K Clear Clock	$I_{IL}$	$V_{CC} = 5.25\text{V}, V_I = 0.4\text{V}$	—	—	-0.4	mA
				—	—	-0.8	
				—	—	-0.8	
	J, K Clear Clock	$I_i$	$V_{CC} = 5.25\text{V}, V_I = 7\text{V}$	—	—	0.1	mA
				—	—	0.3	
—				—	0.4		
Short-circuit output current	$I_{OS}$	$V_{CC} = 5.25\text{V}$	-20	—	-100	mA	
Supply current **	$I_{CC}$	$V_{CC} = 5.25\text{V}$	—	4	6	mA	
Input clamp voltage	$V_{IK}$	$V_{CC} = 4.75\text{V}, I_{IK} = -18\text{mA}$	—	—	-1.5	V	

\*  $V_{CC} = 5\text{V}, T_a = 25^\circ\text{C}$

\*\* With all outputs open,  $I_{CC}$  is measured with the Q and  $\bar{Q}$  outputs high in turn. At the time of measurement, the clock input is grounded.

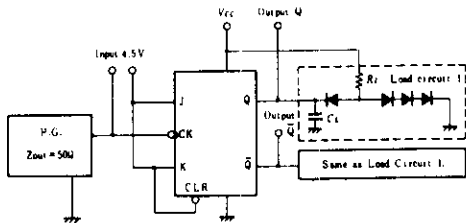
## ■ SWITCHING CHARACTERISTICS ( $V_{CC} = 5\text{V}, T_a = 25^\circ\text{C}$ )

Item	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
Maximum clock frequency	$f_{max}$			$C_L = 15\text{pF}, R_L = 2\text{k}\Omega$	30	45	—	MHz
Propagation delay time	$t_{PLH}$	Clear	Q, $\bar{Q}$		—	15	20	ns
	$t_{PHL}$	Clock			—	15	20	ns

## ■ TESTING METHOD

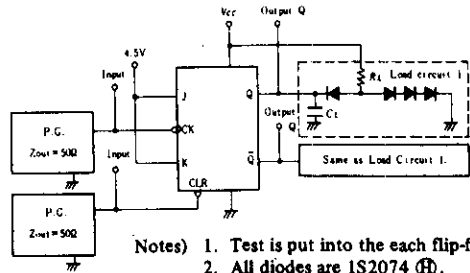
### 1) Test Circuit

#### 1.1) $f_{max}, t_{PLH}, t_{PHL}$ (Clock $\rightarrow$ Q, $\bar{Q}$ )



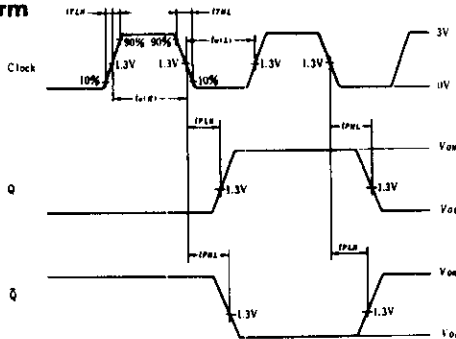
- Notes) 1. Test is put into the each flip-flop.  
2. All diodes are 1S2074 (D).  
3.  $C_L$  includes probe and jig capacitance.

#### 1.2) $t_{PHL}$ (Clear $\rightarrow$ Q), $t_{PLH}$ (Clear $\rightarrow$ $\bar{Q}$ )

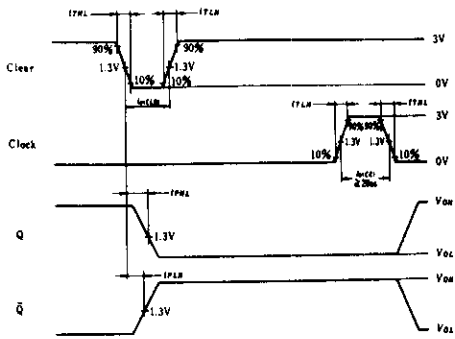


- Notes) 1. Test is put into the each flip-flop.  
2. All diodes are 1S2074 (D).  
3.  $C_L$  includes probe and jig capacitance.

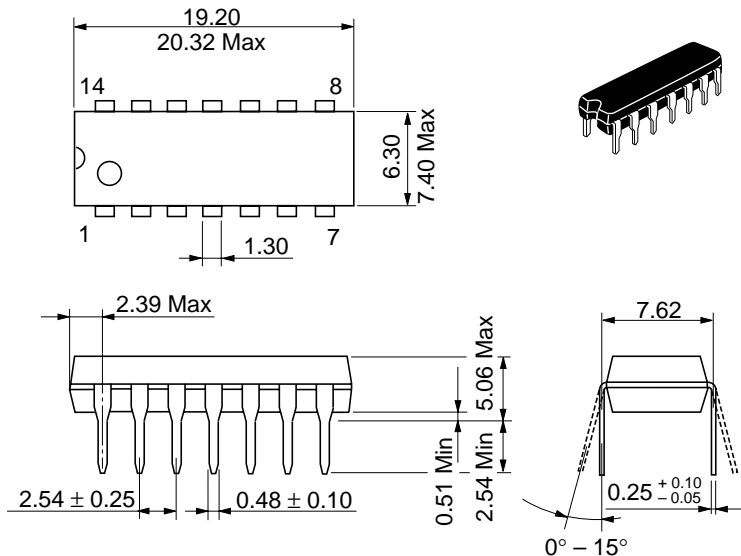
### Waveform



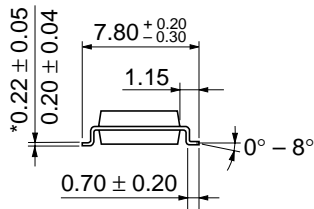
Note) Clock input pulse:  $t_{TLH} \leq 15\text{ns}, t_{THL} \leq 6\text{ns}, \text{PRR} = 1\text{MHz}$ , duty cycle=50% and: for  $f_{max}, t_{TLH} = t_{THL} \leq 2.5\text{ns}$ .



Note) Clear and clock input pulse:  $t_{TLH} \leq 15\text{ns}, t_{THL} \leq 6\text{ns}, \text{PRR} = 1\text{MHz}$



Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g



Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

\*Dimension including the plating thickness  
Base material dimension



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